



# DATA SHEET

## ED1002CS~ED1006CS

### SURFACE MOUNT SUPER FAST RECOVERY RECTIFIER

**VOLTAGE** 200 to 600 Volts **CURRENT** 10 Amperes

TO-252 / DPAK

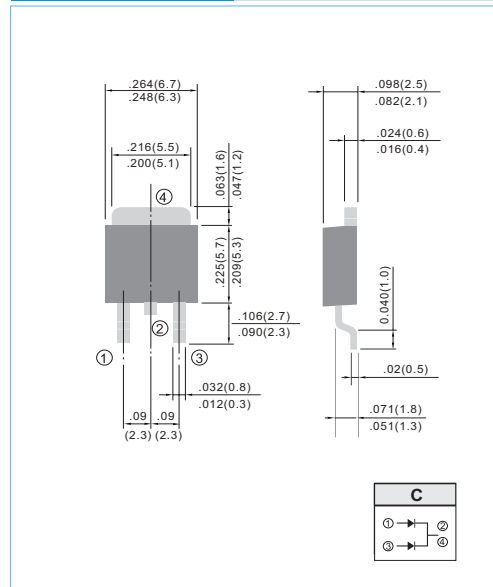
Unit : inch (mm)

#### FEATURES

- For surface mounted applications
- Low profile package
- Built-in strain relief
- Easy pick and place
- Superfast recovery times for high efficiency
- Plastic package has Underwriters Laboratory Flammability Classification 94V-O
- Glass passivated junction
- Both normal and Pb free product are available :  
Normal : 80~95% Sn, 5~20% Pb  
Pb free: 98.5% Sn above

#### MECHANICAL DATA

Case: D PAK/TO-252 molded plastic  
Terminals: Solder plated, solderable per MIL-STD-750, Method 2026  
Polarity: Color band denotes cathode  
Standard packaging: 16mm tape (EIA-481)  
Weight: 0.015 ounce, 0.4 gram.



#### MAXIMUM RATING AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.  
For capacitive load, derate current by 20%

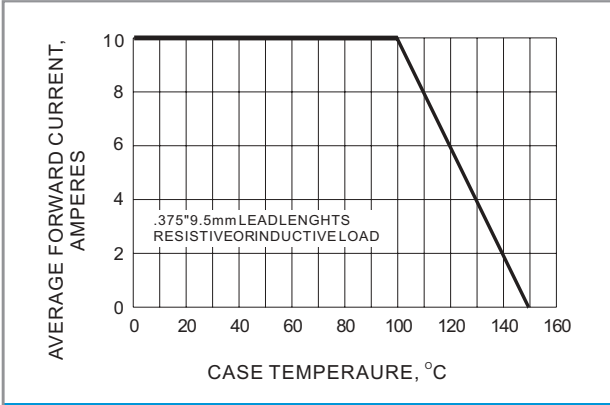
PARAMETER	SYMBOL	ED1002CS	ED1003CS	ED1004CS	ED1006CS	UNITS
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	200	300	400	600	V
Maximum RMS Voltage	V <sub>RMS</sub>	140	210	280	420	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	200	300	400	600	V
Maximum Average Forward Current .375"(9.5mm) lead length at T <sub>c</sub> =100°C	I <sub>AV</sub>	10.0				A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load(JEDEC method)	I <sub>FSM</sub>	100				A
Maximum Forward Voltage at 5.0A	V <sub>F</sub>	0.95	1.3		1.7	V
Maximum DC Reverse Current T <sub>A</sub> =25 °C at Rated DC Blocking Voltage T <sub>A</sub> =100 °C	I <sub>R</sub>	5.0 50				uA
Maximum Reverse Recovery Time (Note 1)	T <sub>RR</sub>	35				ns
Maximum thermal Resistance (Note 2)	R <sub>θJC</sub> R <sub>θJA</sub>	11 80				°C / W
Operating and Storage Temperature Range T <sub>J</sub> , T <sub>STG</sub>	T <sub>J</sub> , T <sub>STG</sub>	-55 TO +150				°C

#### NOTES:

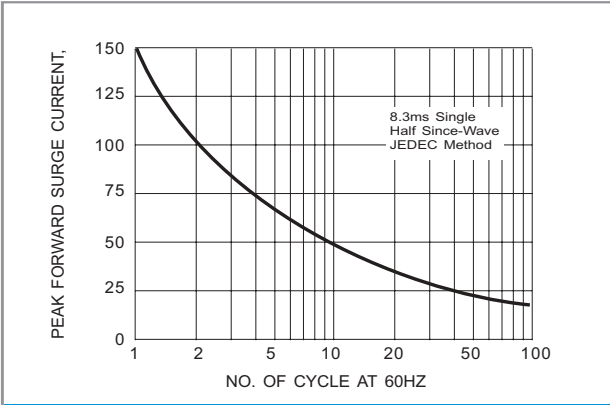
1. Reverse Recovery Test Conditions: I<sub>F</sub>=.5A, I<sub>R</sub>=1A, I<sub>rr</sub>=.25A.
2. Mounted on P.C. Board with 14mm<sup>2</sup> (.013mm thick) copper pad areas.
3. Both Bonding and Chip structure are available.



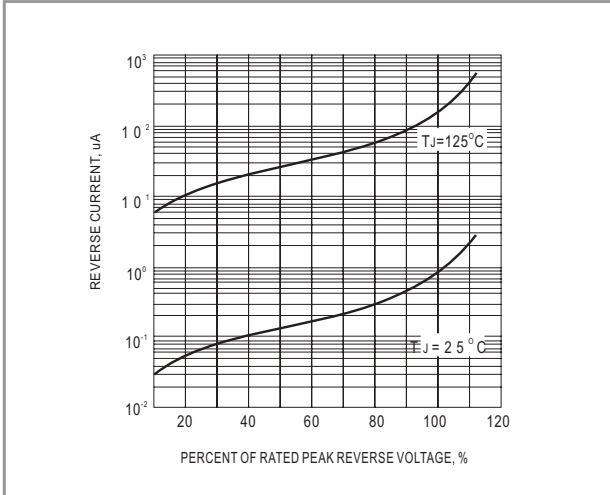
**RATING AND CHARACTERISTIC CURVES**



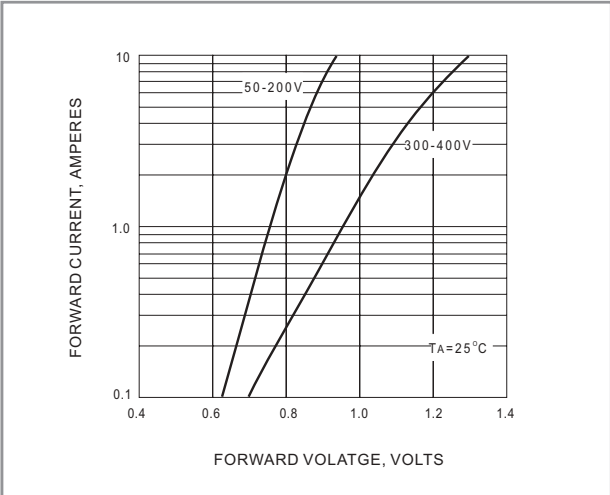
**Fig.1- FORWARD CURRENT DERATING CURVE**



**Fig.2- MAXIMUM NON - REPETITIVE SURGE CURRENT**



**Fig.3- TYPICAL REVERSE CHARACTERISTIC**



**Fig.4- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTIC**